

256K x 8 HIGH-SPEED CMOS STATIC RAM

APRIL 2008

FEATURES

- High-speed access time: 8, 10 ns
- Operating Current: 50mA (typ.)
- Standby Current: 700µA (typ.)
- Multiple center power and ground pins for greater noise immunity
- Easy memory expansion with CE and OE options
- CE power-down
- TTL compatible inputs and outputs
- Single 3.3V power supply
- Packages available:
 - 36-pin 400-mil SOJ
 - 44-pin TSOP (Type II)
- Lead-free available

DESCRIPTION

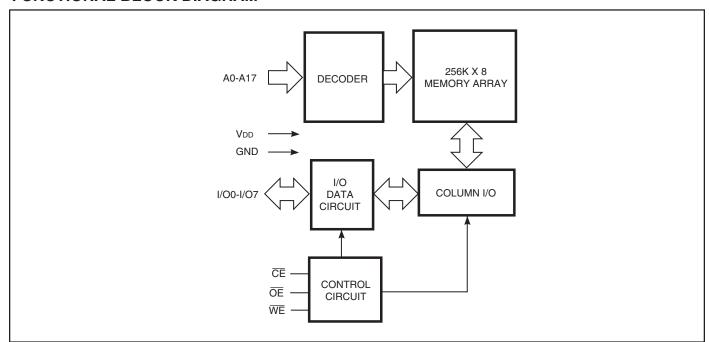
The *ISSI* IS61LV2568L is a very high-speed, low power, 262,144-word by 8-bit CMOS static RAM. The IS61LV2568L is fabricated using *ISSI*'s high-performance CMOS technology. This highly reliable process coupled with innovative circuit design techniques, yields higher performance and low power consumption devices.

When $\overline{\text{CE}}$ is HIGH (deselected), the device assumes a standby mode at which the power dissipation can be reduced down to 36mW (max.) with CMOS input levels.

The IS61LV2568L operates from a single 3.3V power supply and all inputs are TTL-compatible.

The IS61LV2568L is available in 36-pin 400-mil SOJ and 44-pin TSOP (Type II) packages.

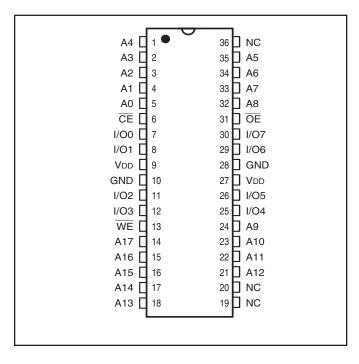
FUNCTIONAL BLOCK DIAGRAM



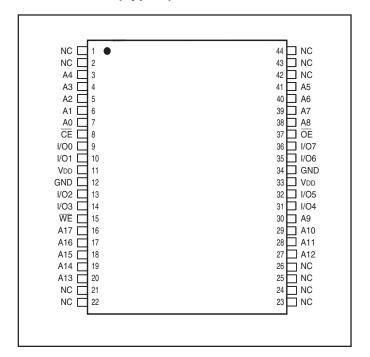
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PIN CONFIGURATION 36-Pin SOJ



44-Pin TSOP (Type II)



PIN DESCRIPTIONS

A0-A17	Address Inputs
CE	Chip Enable Input
ŌĒ	Output Enable Input
WE	Write Enable Input
I/O0-I/O7	Bidirectional Ports
VDD	Power
GND	Ground
NC	No Connection



TRUTH TABLE

Mode	WE	CE	ŌĒ	I/O Operation	V _{DD} Current	
Not Selected (Power-down)	Х	Н	Χ	High-Z	ISB1, ISB2	
Output Disabled	Н	L	Н	High-Z	Icc	
Read	Н	L	L	Dоuт	Icc	
Write	L	L	Х	DIN	Icc	

ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Parameter	Value	Unit	
V _{DD}	Supply voltage with Respect to GND	-0.5 to +4.0	V	
VTERM	Terminal Voltage with Respect to GND	-0.5 to $V_{DD} + 0.5$	V	
Тѕтс	Storage Temperature	-65 to +150	°C	
Po	Power Dissipation	1.0	W	

Notes:

OPERATING RANGE

Range	Ambient Temperature	VDD (8ns)	VDD (10 ns)
Commercial	0°C to +70°C	3.3V +10%,-5%	3.3V <u>+</u> 10%
Industrial	-40°C to +85°C		3.3V <u>+</u> 10%

DC ELECTRICAL CHARACTERISTICS (Over Operating Range)

Symbol	Parameter	Test Conditions	Min.	Max.	Unit
Vон	Output HIGH Voltage	V _{DD} = Min., Iон = -4.0 mA	2.4	_	V
Vol	Output LOW Voltage	VDD = Min., IOL = 8.0 mA	_	0.4	V
VIH	Input HIGH Voltage(1)		2.0	V _{DD} + 0.3	V
VIL	Input LOW Voltage(1)		-0.3	0.8	V
ILI	Input Leakage	GND ≤ V _{IN} ≤ V _{DD}	-1	1	μA
ILO	Output Leakage	GND ≤ Vouт ≤ Vdd, Outputs Disabled	-1	1	μΑ

Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a
stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational
sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect
reliability.

^{1.} $V_{IL}(min) = -0.3V$ (DC); $V_{IL}(min) = -2.0V$ (pulse width - 2.0 ns). $V_{IH}(max) = V_{DD} + 0.3V$ (DC); $V_{IH}(max) = V_{DD} + 2.0V$ (pulse width - 2.0 ns).



POWER SUPPLY CHARACTERISTICS⁽¹⁾ (Over Operating Range)

Symbol	Parameter	Test Conditions		_	ns Max.		ns Max.	Unit
lcc	VDD Operating Supply Current	$V_{DD} = Max., \overline{CE} = V_{IL}$ $I_{OUT} = 0 \text{ mA}, f = Max.$	Com. Ind. typ. ⁽²⁾	_	65 50	_ _ _	60 65 50	mA
ISB1	TTL Standby Current (TTL Inputs)	V _{DD} = Max., V _{IN} = V _{IH} or V _{IL} CE ≥ V _{IH} , f = max	Com. Ind.		30	_	25 30	mA
ISB2	CMOS Standby Current (CMOS Inputs)	$\begin{split} & V_{DD} = Max., \\ & \overline{CE} \geq V_{DD} - 0.2V, \\ & V_{IN} \geq V_{DD} - 0.2V, \text{ or } \\ & V_{IN} \leq 0.2V, f = 0 \end{split}$	Com. Ind. typ. ⁽²⁾	-	3 700		3 4 700	mA mA μA

Note:

CAPACITANCE(1,2)

Symbol	Parameter	Conditions	Max.	Unit
CIN	Input Capacitance	$V_{IN} = 0V$	6	pF
Cı/o	Input/Output Capacitance	Vout = 0V	8	рF

- 1. Tested initially and after any design or process changes that may affect these parameters.
- 2. Test conditions: $T_A = 25^{\circ}C$, f = 1 MHz, $V_{DD} = 3.3V$.

^{1.} At f = fmax, address and data inputs are cycling at the maximum frequency, f = 0 means no input lines change.

^{2.} Typical values are measured at V_{DD}=3.3V, T_A=25°C. Not 100% tested.



AC TEST CONDITIONS

Parameter	Unit
Input Pulse Level	0V to 3.0V
Input Rise and Fall Times	3 ns
Input and Output Timing and Reference Levels	1.5V
Output Load	See Figures 1 and 2

AC TEST LOADS

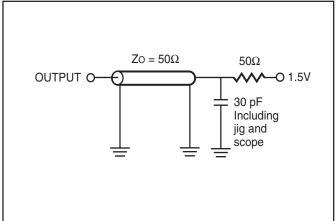
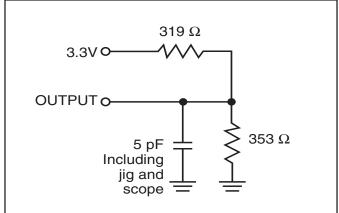


Figure 2 Figure 1





READ CYCLE SWITCHING CHARACTERISTICS⁽¹⁾ (Over Operating Range)

		- 8 ns		-10	ns	
Symbol	Parameter	Min.	Max	Min.	Max.	Unit
trc	Read Cycle Time	8	_	10	_	ns
taa	Address Access Time	_	8	_	10	ns
tона	Output Hold Time	2.5	_	2.5	_	ns
tace	CE Access Time	_	8	_	10	ns
tdoe	OE Access Time	_	3.5	_	4	ns
tlzoe(2)	OE to Low-Z Output	0	_	0	_	ns
thzoe(2)	OE to High-Z Output	0	3.5	0	4	ns
tLZCE ⁽²⁾	CE to Low-Z Output	3.5	_	3	_	ns
thzce(2)	CE to High-Z Output	0	3.5	0	4	ns

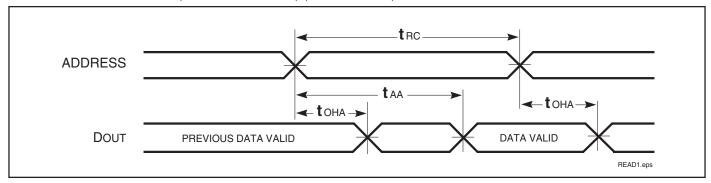
^{1.} Test conditions assume signal transition times of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V and output loading specified in Figure 1.

2. Tested with the load in Figure 2. Transition is measured ±200 mV from steady-state voltage. Not 100% tested.

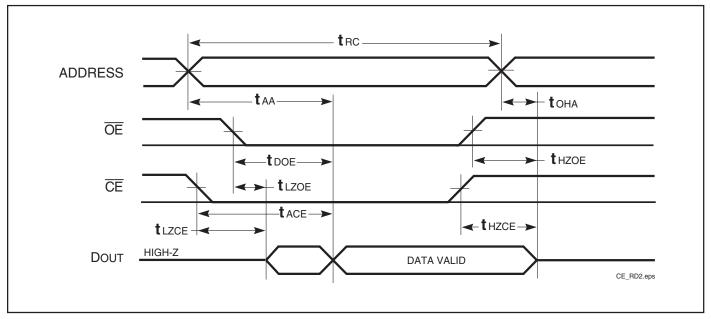


AC WAVEFORMS

READ CYCLE NO. $1^{(1,2)}$ (Address Controlled) ($\overline{CE} = \overline{OE} = V_{IL}$)



READ CYCLE NO. $2^{(1,3)}$ ($\overline{\text{CE}}$ and $\overline{\text{OE}}$ Controlled)



- 1. WE is HIGH for a Read Cycle.
- 2. The device is continuously selected. \overline{OE} , $\overline{CE} = V_{IL}$.
- 3. Address is valid prior to or coincident with $\overline{\text{CE}}$ LOW transitions.



WRITE CYCLE SWITCHING CHARACTERISTICS(1,2) (Over Operating Range)

		- 8	ns	-10	ns	
Symbol	Parameter	Min.	Max	Min.	Max.	Unit
twc	Write Cycle Time	8	_	10	_	ns
tsce	CE to Write End	7	_	8	_	ns
taw	Address Setup Time to Write End	7	_	8	_	ns
tha	Address Hold from Write End	0	_	0	_	ns
tsa	Address Setup Time	0	_	0	_	ns
t _{PWE1}	WE Pulse Width (OE = HIGH)	6	_	7	_	ns
tPWE2	WE Pulse Width (OE = LOW)	6.5	_	8	_	ns
tsp	Data Setup to Write End	4	_	5	_	ns
thd	Data Hold from Write End	0	_	0	_	ns
thzwe ⁽³⁾	WE LOW to High-Z Output	_	3	_	4	ns
tLZWE ⁽³⁾	WE HIGH to Low-Z Output	0	_	0	_	ns

^{1.} Test conditions assume signal transition times of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V and output loading specified in Figure 1.

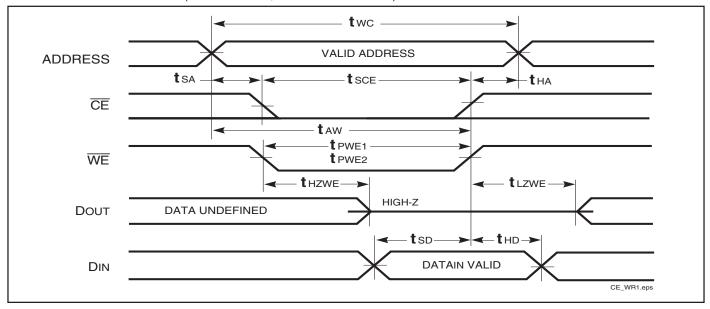
^{2.} The internal write time is defined by the overlap of $\overline{\textbf{CE}}$ LOW and $\overline{\textbf{WE}}$ LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the Write.

^{3.} Tested with the load in Figure 2. Transition is measured ±500 mV from steady-state voltage. Not 100% tested.



AC WAVEFORMS

WRITE CYCLE NO. $1^{(1,2)}$ (\overline{CE} Controlled, \overline{OE} = HIGH or LOW)



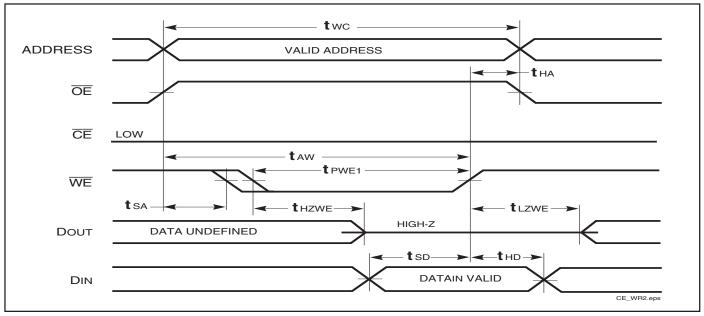
Note:

1. The internal Write time is defined by the overlap of $\overline{\textbf{CE}}$ = LOW and $\overline{\textbf{WE}}$ = LOW. All signals must be in valid states to initiate a Write, but any can be deasserted to terminate the Write. The Data Input Setup and Hold timing is referenced to the rising or falling edge of the signal that terminates the Write.



AC WAVEFORMS

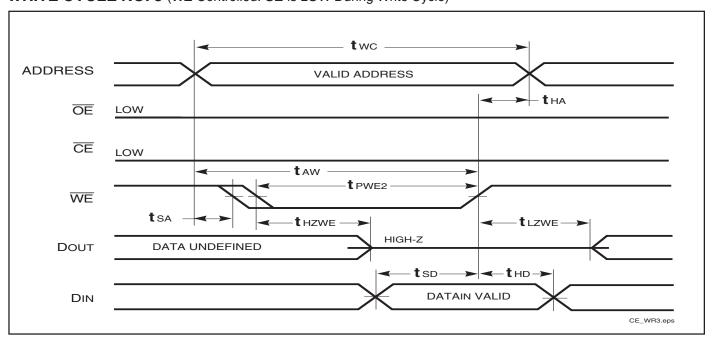
WRITE CYCLE NO. $2^{(1)}$ (WE Controlled, \overline{OE} = HIGH during Write Cycle)



Note:

1. The internal Write time is defined by the overlap of $\overline{\textbf{CE}}$ = LOW and $\overline{\textbf{WE}}$ = LOW. All signals must be in valid states to initiate a Write, but any can be deasserted to terminate the Write. The Data Input Setup and Hold timing is referenced to the rising or falling edge of the signal that terminates the Write.

WRITE CYCLE NO. 3 (WE Controlled: OE is LOW During Write Cycle)



Note:

1. The internal Write time is defined by the overlap of $\overline{CE} = LOW$ and $\overline{WE} = LOW$. All signals must be in valid states to initiate a Write, but any can be deasserted to terminate the Write. The Data Input Setup and Hold timing is referenced to the rising or falling edge of the signal that terminates the Write.



ORDERING INFORMATION

Commercial Range: 0°C to +70°C

Speed (ns)	Order Part No.	Package
8	IS61LV2568L-8K IS61LV2568L-8T IS61LV2568L-8TL	400-mil SOJ TSOP (Type II) TSOP (Type II), Lead-free
10	IS61LV2568L-10T IS61LV2568L-10TL	TSOP (Type II) TSOP (Type II), Lead-free

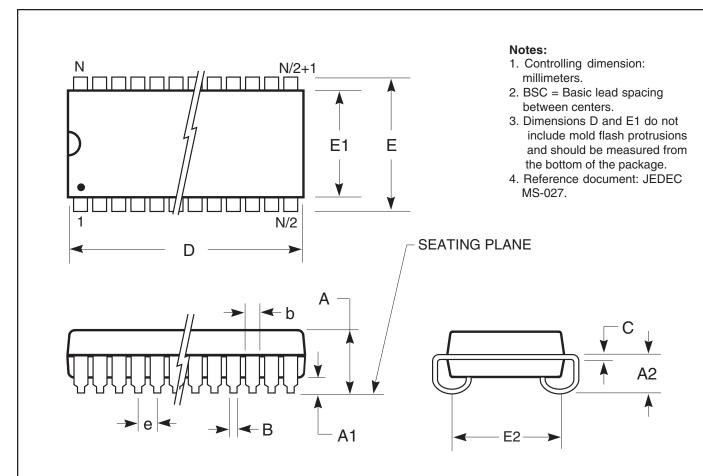
Industrial Range: -40°C to +85°C

Speed (ns)	Order Part No.	Package
10	IS61LV2568L-10KI	400-mil SOJ
	IS61LV2568L-10KLI	400-mil SOJ, Lead-free

PACKAGING INFORMATION



400-mil Plastic SOJ Package Code: K



	Millimeters		Inches		Millim	Millimeters		Inches		Millimeters		es
Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max
No. Leads	(N)	28				3	2				36	
Α	3.25	3.75	0.128	0.148	3.25	3.75	0.128	0.148	3.25	3.75	0.128	0.148
A1	0.64	_	0.025	_	0.64	_	0.025	_	0.64	_	0.025	_
A2	2.08	_	0.082	_	2.08	_	0.082	_	2.08	_	0.082	_
В	0.38	0.51	0.015	0.020	0.38	0.51	0.015	0.020	0.38	0.51	0.015	0.020
b	0.66	0.81	0.026	0.032	0.66	0.81	0.026	0.032	0.66	0.81	0.026	0.032
С	0.18	0.33	0.007	0.013	0.18	0.33	0.007	0.013	0.18	0.33	0.007	0.013
D	18.29	18.54	0.720	0.730	20.82	21.08	0.820	0.830	23.37	23.62	0.920	0.930
Е	11.05	11.30	0.435	0.445	11.05	11.30	0.435	0.445	11.05	11.30	0.435	0.445
E1	10.03	10.29	0.395	0.405	10.03	10.29	0.395	0.405	10.03	10.29	0.395	0.405
E2	9.40	BSC	0.370) BSC	9.40	BSC	0.370	BSC	9.40	BSC	0.370	BSC
е	1.27	BSC	0.05	0 BSC	1.27 E	3SC	0.050) BSC	1.27	BSC	0.050) BSC

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PACKAGING INFORMATION



	Millimeters		Inches		Millim	Millimeters		Inches		Millimeters		Inches	
Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
No. Leads	(N)	4	0			42			44				
Α	3.25	3.75	0.128	0.148	3.25	3.75	0.128	0.148	3.25	3.75	0.128	0.148	
A1	0.64	_	0.025	_	0.64	_	0.025	_	0.64	_	0.025	_	
A2	2.08	_	0.082	_	2.08	_	0.082	_	2.08	_	0.082	_	
В	0.38	0.51	0.015	0.020	0.38	0.51	0.015	0.020	0.38	0.51	0.015	0.020	
b	0.66	0.81	0.026	0.032	0.66	0.81	0.026	0.032	0.66	0.81	0.026	0.032	
С	0.18	0.33	0.007	0.013	0.18	0.33	0.007	0.013	0.18	0.33	0.007	0.013	
D	25.91	26.16	1.020	1.030	27.18	27.43	1.070	1.080	28.45	28.70	1.120	1.130	
Е	11.05	11.30	0.435	0.445	11.05	11.30	0.435	0.445	11.05	11.30	0.435	0.445	
E1	10.03	10.29	0.395	0.405	10.03	10.29	0.395	0.405	10.03	10.29	0.395	0.405	
E2	9.40 BSC		0.370 BSC		9.40	9.40 BSC		0.370 BSC		9.40 BSC		0.370 BSC	
е	1.27 BSC		0.05	0 BSC	BSC 1.27 E		SC 0.050 BSC		1.27 BSC		0.050 BSC		

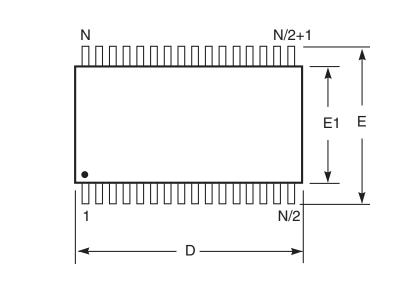
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PACKAGING INFORMATION



Plastic TSOP

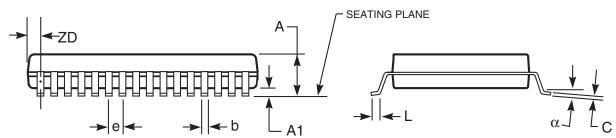
Package Code: T (Type II)



Notes:

- 1. Controlling dimension: millimieters, unless otherwise specified.
- unless otherwise specified.

 BSC = Basic lead spacing between centers.
- Dimensions D and E1 do not include mold flash protrusions and should be measured from the bottom of the package.
- Formed leads shall be planar with respect to one another within 0.004 inches at the seating plane.



Plastic TSOP (T - Type II)													
	Millimeters		Inches		Millim	Millimeters		Inches		Millimeters		Inches	
Symbol	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
Ref. Std.													
No. Leads	(N)	32				44	1			50			
Α	_	1.20	_	0.047	_	1.20	_	0.047	_	1.20	_	0.047	
A1	0.05	0.15	0.002	0.006	0.05	0.15	0.002	0.006	0.05	0.15	0.002	0.006	
b	0.30	0.52	0.012	0.020	0.30	0.45	0.012	0.018	0.30	0.45	0.012	0.018	
С	0.12	0.21	0.005	0.008	0.12	0.21	0.005	0.008	0.12	0.21	0.005	0.008	
D	20.82	21.08	0.820	0.830	18.31	18.52	0.721	0.729	20.82	21.08	0.820	0.830	
E1	10.03	10.29	0.391	0.400	10.03	10.29	0.395	0.405	10.03	10.29	0.395	0.405	
Е	11.56	11.96	0.451	0.466	11.56	11.96	0.455	0.471	11.56	11.96	0.455	0.471	
е	1.27 BSC		0.050 I	0.050 BSC		0.80 BSC		0.032 BSC		0.80 BSC		0.031 BSC	
L	0.40	0.60	0.016	0.024	0.41	0.60	0.016	0.024	0.40	0.60	0.016	0.024	
ZD	0.95 REF		0.037 REF		0.81	0.81 REF		0.032 REF		0.88 REF		0.035 REF	
α	0°	5°	0°	5°	0°	5°	0°	5°	0°	5°	0°	5°	

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CY7C1353S-100AXC AS6C8016-55BIN AS7C164A-15PCN 515712X IDT71V67603S133BG IS62WV51216EBLL-45BLI

IS63WV1288DBLL-10HLI IS66WVE2M16ECLL-70BLI IS66WVE4M16EALL-70BLI IS62WV6416DBLL-45BLI IS61WV102416DBLL
10TLI CY7C1381KV33-100AXC CY7C1381KVE33-133AXI 8602501XA 5962-3829425MUA 5962-3829430MUA 5962-8855206YA

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GS882Z18CD-150I M38510/28902BVA 8413202RA 5962-9161708MYA 5962-8971203XA 5962-8971202ZA 5962-8872501LA 5962-8866208YA 5962-8866205YA 5962-8866205YA 5962-8866205UA 5962-8866203YA 5962-8866205YA 5962-88667519XA